

Vishay Siliconix

N-Channel 30 V (D-S) MOSFET



PRODUCT SUMMARY					
V _{DS} (V)	30				
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 10 \text{ V}$	0.021				
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 4.5 \text{ V}$	0.033				
Q _g typ. (nC)	3.7				
I _D (A) ^a	12				
Configuration	Single				

FEATURES

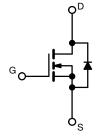
- TrenchFET® power MOSFET
- 100% R_g and UIS tested
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912



ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

- Notebook system power
- Low current DC/DC



N-Channel MOSFET

ORDERING INFORMATION	
Package	SO-8
Lead (Pb)-free and halogen-free	Si4178DY-T1-GE3

ABSOLUTE MAXIMUM RATING	iS (T _A = 25 °C, u	ınless otherv	vise noted)	
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V_{DS}	30	V
Gate-source voltage	Gate-source voltage		± 25	V
	T _C = 25 °C		12 ^a	
Continuous dusin surrent /T 150 °C)	T _C = 70 °C	T , [9.7 ^a	
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	l _D	8.3 ^{b, c}	
	T _A = 70 °C	1	6.7 ^{b, c}	•
Pulsed drain current		I _{DM}	40	— A
Canting and a summer	T _C = 25 °C	- I _S	4.2	
Continuous source-drain diode current	T _A = 25 °C		2 b, c	
Single pulse avalanche current	1 0111	I _{AS}	10	
Single pulse avalanche energy	L = 0.1 mH	E _{AS}	5	mJ
Maximum power dissipation	T _C = 25 °C		5	
	T _C = 70 °C	1 5	3.2	w
	T _A = 25 °C	P _D	2.4 ^{b, c}	VV
	T _A = 70 °C		1.5 ^{b, c}	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum junction-to-ambient b, d	t ≤ 10 s	R_{thJA}	42	53	°C/W	
Maximum junction-to-foot (drain)	Steady state	R_{thJF}	19	25	C/VV	

Notes

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s
- d. Maximum under steady state conditions is 85 °C/W



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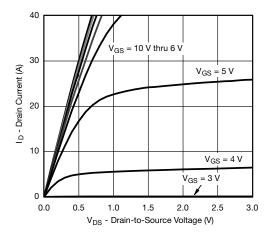
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static			<u>'</u>			•	
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	1 050 A	-	25	-	mV/°C	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-6	-		
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.4	-	2.8	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$	-	-	± 100	nA	
Zara gata valtaga drain avrent		V _{DS} = 30 V, V _{GS} = 0 V	-	-	1	μА	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C	-	-	10		
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	20	-	-	Α	
Desire a service della contaba		$V_{GS} = 10 \text{ V}, I_D = 8.4 \text{ A}$	-	0.017	0.021		
Drain-source on-state resistance a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 2 A	-	0.027	0.033	Ω	
Forward transconductance a	9 _{fs}	V _{DS} = 15 V, I _D = 8.4 A	-	22	-	S	
Dynamic ^b							
Input capacitance	C _{iss}		-	405	-		
Output capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	110	-	pF	
Reverse transfer capacitance	C _{rss}		-	56	-	1	
	Qg	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 8.4 \text{ A}$	-	7.5	12	nC	
Total gate charge		<u> </u>	-	3.7	5.6		
Gate-source charge	Q _{qs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 8.4 \text{ A}$	-	1.6	=.		
Gate-drain charge	Q _{gd}		-	1.3	-		
Gate resistance	R _g	f = 1 MHz	0.5	2.6	5.2	Ω	
Turn-on delay time	t _{d(on)}		-	20	30		
Rise time	t _r	$V_{DD} = 15 \text{ V}, R_L = 2.2 \Omega$	-	15	25	1	
Turn-off delay time	t _{d(off)}	$I_D \cong 6.7 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	11	20		
Fall time	t _f		-	10	15		
Turn-on delay time	t _{d(on)}		-	7	15	ns	
Rise time	t _r	$V_{DD} = 15 \text{ V}, \text{ RL} = 2.2 \Omega$	-	10	15	- - -	
Turn-off delay time	t _{d(off)}	$I_D \cong 6.7 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	12	20		
Fall time	t _f		-	10	15	1	
Drain-Source Body Diode Characterist	cs		<u>'</u>	•			
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	4.2	_	
Pulse diode forward current	I _{SM}		-	-	40	A	
Body diode voltage	V _{SD}	I _S = 6.7 A, V _{GS} = 0 V	-	0.85	1.2	V	
Body diode reverse recovery time	t _{rr}		-	15	30	ns	
Body diode reverse recovery charge	Q _{rr}	$I_F = 6.7 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s,}$	_	8	16	nC	
Reverse recovery fall time	ta	$T_{\rm J} = 25 ^{\circ}{\rm C}$	_	8.5	-		
Reverse recovery rise time	t _b		_	6.5	_	ns	

Notes

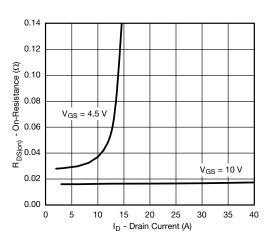
- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2%
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

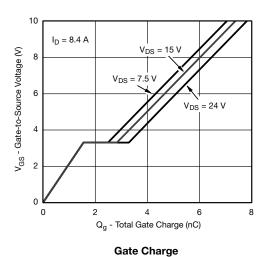




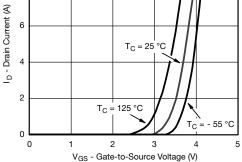
Output Characteristics



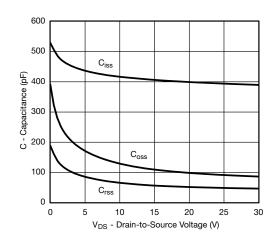
On-Resistance vs. Drain Current



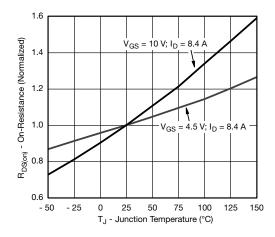
10 8 (V) tu₀ 6



Transfer Characteristics

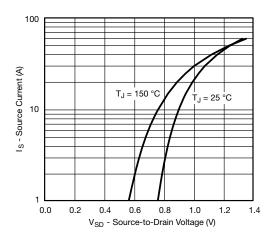


Capacitance

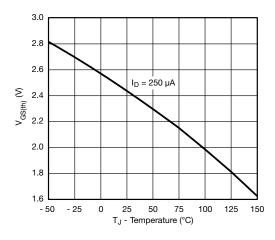


On-Resistance vs. Junction Temperature

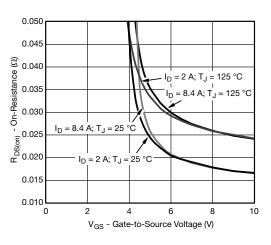




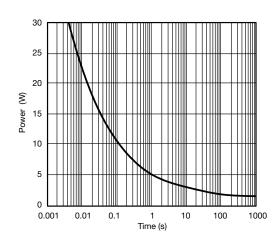
Source-Drain Diode Forward Voltage



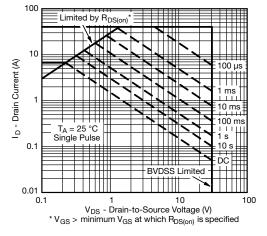
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage

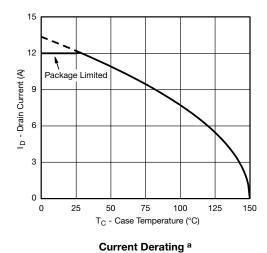


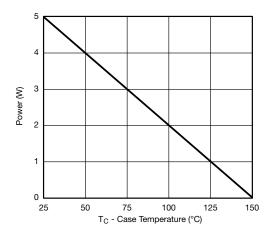
Single Pulse Power



Safe Operating Area, Junction-to-Ambient





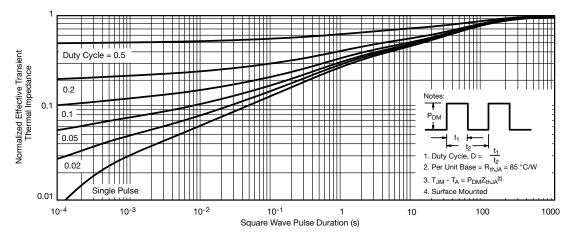


Power Derating

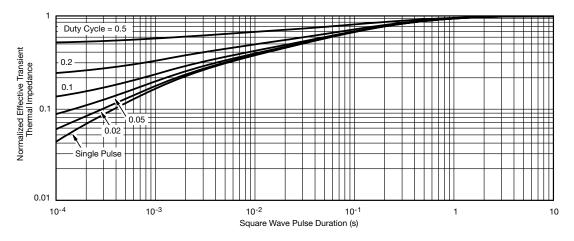
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for silicon technology and package reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?65718.



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INC	INCHES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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